







UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D.C. 20231
www.uspto.gov

	APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
	09/698,817	10/26/2000	Martin Theriault	016499-777	6414
	7:	590 08/23/2002			
	09/698,817 10/26/2000 Martin Theriault	EXAMINER			
		PHAN, THIEM D			
	Alexandria, VA	22313-1404		ART UNIT	PAPER NUMBER
				3729	
				DATE MAILED: 08/23/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

		S.M.				
	Application No.	Applicant(s)				
Office Action Comment	09/698,817	THERIAULT ET AL.				
Office Action Summary	Examiner	Art Unit				
	Tim Phan	3729				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
1)⊠ Responsive to communication(s) filed on <u>26 October 2000</u> .						
	is action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims						
4)⊠ Claim(s) <u>1-18</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-18</u> is/are rejected.						
7) Claim(s) is/are objected to.	7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.  Application Papers						
9) ☐ The specification is objected to by the Examiner.						
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12) The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
<ul> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
<ul> <li>a)  The translation of the foreign language provisional application has been received.</li> <li>15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.</li> </ul>						
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 5	5) Notice of Informal	y (PTO-413) Paper No(s) Patent Application (PTO-152)				
U.S. Patent and Trademark Office	etion Summan	Part of Paner No. 6				

Art Unit: 3729

## **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

2. Claims 1-5 are rejected under 35 U.S.C. 102(e) as being anticipated by Ochoa et al (USPN 6,054,682).

Ochoa et al disclose a system for reducing water vapor in integrated circuit packaging on printed circuit board, the system comprises:

a component storage area (fig. 4, item 101; column 4, lines 35-36),

Art Unit: 3729

- a component placement system for taking components from component storage area and placing them on printed circuit boards or pick and place machine (column 4, line 34),
- an enclosure surrounding the component storage area where the components chamber must be enclosed in order to be heated up (fig. 4, item 111; column 4, line 33, lines 35-36),
- a dry gas delivery system to storage area to maintain a dry atmosphere and to prevent moisture from being absorbed by the components, that utilizes heating, vacuuming and inserting inert gas in the components chamber to get rid of the water vapor (column 4, lines 61-66), including deionized air (column 9, line 1, lines 7-8).

In regard to claims 2-5, Ochoa et al disclose the components fed to PCB placement machine in parts trays, parts in a tape or reel and loose parts in a tube or sticks (column 1, lines 19-20), specially with the bulk storage of reels to optimize manufacturing (fig. 4, item 101; column 6, lines 44-48).

3. Claims 9-13 are rejected under 35 U.S.C. 102(e) as being anticipated by Ochoa et al.

Ochoa et al disclose a method for reducing water vapor in integrated circuit packaging on printed circuit board, comprising:

- storing electronic components in storage area (fig. 4, item 111; column 4, lines 35-36) of a surface mount device placement machine or "pick and place machine" for the SMT or reflow soldering (column 2, lines 4-5),
- maintaining dry atmosphere in storage area and injecting dry gas through heating, vacuuming and inserting inert gas in the components chamber (column 4, lines 61-66), including deionized air (column 9, line 1, lines 7-8),
- removing components from storage area (fig. 3, item 101),
- mounting the components on printed circuit board (column 6, lines 24-25).

In regard to claims 10-13, Ochoa et al disclose the components fed to PCB placement machine in parts trays, parts in a tape or reel and loose parts in a tube or sticks (column 1, lines 19-20), specially with the bulk storage of reels to optimize manufacturing (fig. 4, item 101, column 6, lines 44-48).

## Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Application/Control Nober: 09/698,817

Art Unit: 3729

Claims 6-8, 14-17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ochoa et al in view of Vander Velde (USPN 5,365,779). In regard to claims 6, 14 and 15, Ochoa et al disclose a system for reducing water vapor in integrated circuit packaging, which meets all of applicant's claimed limitations except for teaching the controlled dry gas delivery system with a moisture sensor. However, Vander Velde teaches a system (figure 1, column 5, lines 9-32) that supplies non-corrosive dry gas (item 24) to the inlet port (item 20) of a prestressing element (item 16) lay inside and along the concrete structure (item 14), samples at the outlet (item 26) of that conduit the humidity level with a moisture sensor (item 30) and uses the feedback to control the flow rate of dry gas in order to evaluate the humidity level or corrosion of that concrete structure, dry it out through continuous non-corrosive dry gas (column 4, lines 12-15) then seal it off for protection (column 15, lines 41-44).

Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Ochoa et al's method by applying the references of drying out the moisture from an enclosed area rather than the bodily structure as taught by Vander Velde in order to facilitate and improve the treatment of moisture problem in the component packaging, avoiding any "popcorn effect" (Ochoa et al, column 4, line 1).

In regard to claims 7-8 and 16-17, Vander Velde discloses that the flow rate and pressure of dry non-corrosive gas is controlled by a regulator (column 5, lines 21-22) to monitor the flow rate, thus an unobstructed flow or first flow of dry gas through the open

Application/Control N eer: 09/698,817

Art Unit: 3729

components chamber is always higher than a blocked one or second flow of dry gas through a closed chamber.

6. Claim 18 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ochoa et al in view of Alles et al (USPN 5,297,438).

Ochoa et al disclose a system for reducing water vapor in integrated circuit packaging, which meets all of applicant's claimed limitations except for drying out or removing about 0.1% or more the moisture from the components weight. However, Alles et all teaches the drying effect of less than 1% moisture of the filter cake passing through the heated oven (column 8, line 62) in the making of the piezoresistive sensor.

Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Ochoa et al's method by applying the reference/ specification of drying out the moisture from a material in an enclosed area as taught by Alles et al in order lower the humidity from the component then avoiding the "popcorn effect" during reflow soldering.

## Conclusion

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tim Phan whose telephone number is 703-605-0707. The examiner can normally be reached on Monday - Friday, 9AM - 5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Peter VO can be reached on 703-308-1789. The fax phone numbers for the organization where this application or proceeding is assigned are 703-872-9302 for regular communications and 703-872-9303 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-1148.

Tim Phan Examiner Art Unit 3729 PETER VO SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 3700

tp August 20, 2002